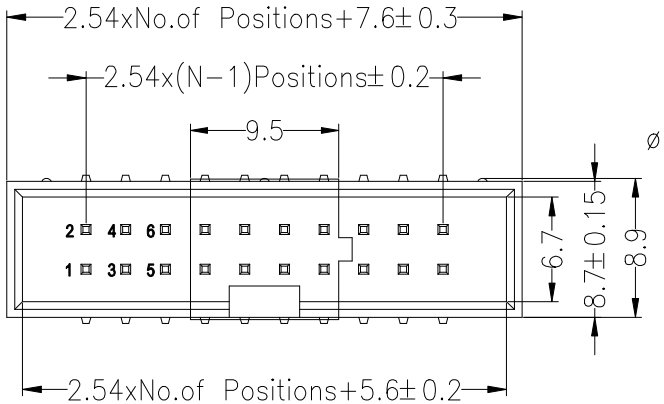
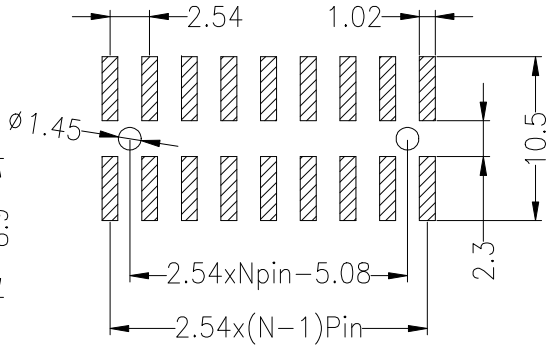
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



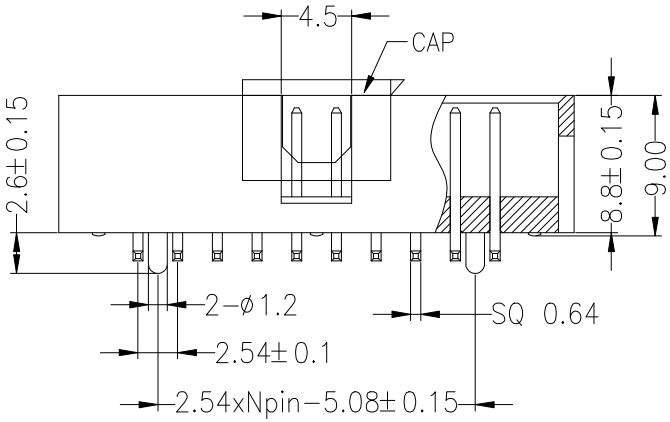
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

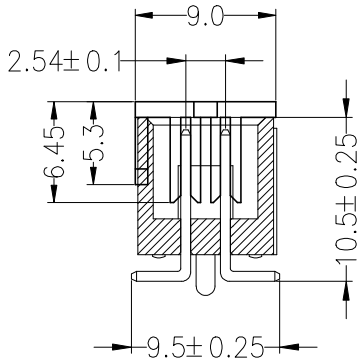


Ordering Information

3210 XX M XX X B K00 X 0X

- No.of Pins: 06−64P
- Contact Plating: G0:Gold Flash; G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; G6:10U" Gold; G7:15U" Gold; S0:Gold Flash/Tin; SN:Tin
- Insulator Material Option: C=PA6T; E=PA9T; F=LCP
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap
- Stream code: 01~99





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.08.17	NEW DRAWING	

OPERATION		DRAW	Liu Miao	21.08.17	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3210XXMXXXBK00X0X
TITLE:	2.54mm Box Header H8.8mm SMT 内柱